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DATA SHEET www.onsemi.com

ESD Protection Diode Array, Quad, Low Capacitance

NUP45V6P5

This integrated surge protection is designed for applications requiring transient overvoltage protection. It is intended to be used in sensitive equipment such as wireless headsets, PDAs, digital cameras, computers, printers, communication systems, and other applications. The integrated design provides very effective and reliable protection for four separate lines using only one package. This device is ideal for situations where board space is at a premium.

Features

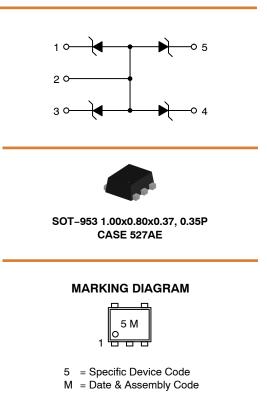
- ESD Protection: IEC61000-4-2: Level 4
- Four Separate Unidirectional Configurations for Protection
- Low Leakage Current < 1 µA @ 3 V
- Small SOT-953 SMT Package
- Low Capacitance
- These are Pb–Free Devices

Benefits

- Provides Protection for ESD Industry Standards: IEC 61000, HBM
- Protects Four Lines Against Transient Voltage Conditions
- Minimize Power Consumption of the System
- Minimize PCB Board Space

Typical Applications

- Cellular and Portable Electronics
- Serial and Parallel Ports
- Microprocessor Based Equipment
- Notebooks, Desktops, Servers



ORDERING INFORMATION

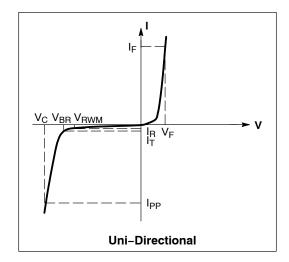
Device	Package	Shipping [†]
NUP45V6P5T5G	SOT-953 (Pb-Free)	8000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

Symbol	Parameter				
I _{PP}	Maximum Reverse Peak Pulse Current				
V _C	Clamping Voltage @ IPP				
V _{RWM}	Working Peak Reverse Voltage				
I _R	Maximum Reverse Leakage Current @ V _{RWM}				
V _{BR}	Breakdown Voltage @ I _T				
Ι _Τ	Test Current				
ΘV _{BR}	Maximum Temperature Coefficient of V_{BR}				
١ _F	Forward Current				
V _F	Forward Voltage @ I _F				
Z _{ZT}	Maximum Zener Impedance @ IZT				
I _{ZK}	Reverse Current				
Z _{ZK}	Maximum Zener Impedance @ IZK				



MAXIMUM RATINGS ($T_A = 25^{\circ}C$ unless otherwise noted)

Characteristic	Symbol	Value	Unit
Thermal Resistance Junction-to-Ambient Above 25°C, Derate	R _{θJA}	560 4.5	°C/W mW/°C
Maximum Junction Temperature	T _{Jmax}	150	°C
Operating Junction and Storage Temperature Range	T _J T _{stg}	–55 to +150	°C
Lead Solder Temperature (10 seconds duration)	TL	260	°C
Human Body Model (HBM) Machine Model (MM)	ESD	8000 400	V

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

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(参考訳)

最大定格を超えるストレスは、デバイスにダメージを与える危険性があります。これらの定格値を超えた場合は、デバイスの機能性を損ない、ダメージが生じ、信頼性に影響を及ぼす危険性があります。

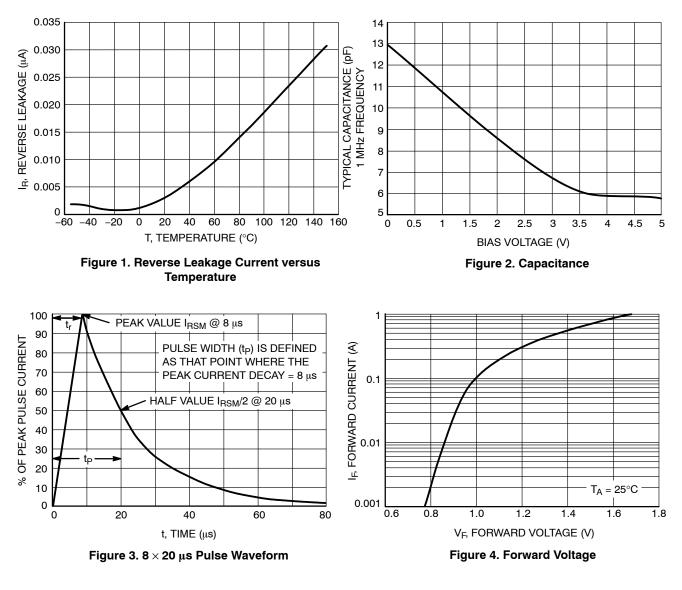
ELECTRICAL CHARACTERISTICS (T_A = 25°C)

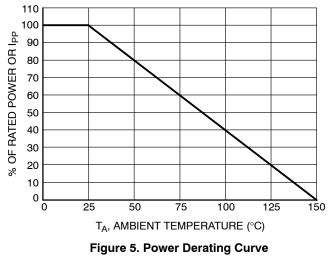
	Device	Breakdown Voltage V _{BR} @ 1 mA (Volts)		Leakage Current I _{RM} @ V _{RM}		Typ Capacitance @ 0 V Bias (pF) (Note 1)		Typ Capacitance @ 3 V Bias (pF) (Note 1)		V _C (V) @ I _{PP} = 1 A (Note 2)	
Device	Marking	Min	Nom	Max	V _{RWM}	I _{RWM} (μΑ)	Тур	Max	Тур	Max	Max
NUP45V6P5	5	5.3	5.6	5.9	3.0	1.0	13	17	7.0	11.5	10.5

1. Capacitance of one diode at f = 1 MHz, $T_A = 25^{\circ}C$. 2. Surge current waveform per Figure 3.

NUP45V6P5

TYPICAL ELECTRICAL CHARACTERISTICS







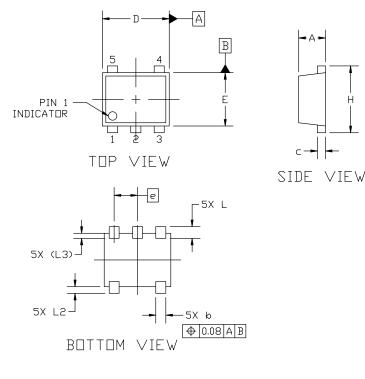


SOT-953 1.00x0.80x0.37, 0.35P CASE 527AE ISSUE F

DATE 17 JAN 2024

NDTES:

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2018.
- 2. CONTROLLING DIMENSION: MILLIMETERS.
- 3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS DF THE BASE MATERIAL.
- 4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.



GENERIC MARKING DIAGRAM*

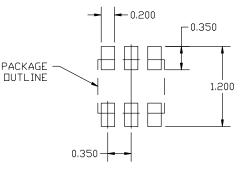


- X = Specific Device Code M = Month Code
- *This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

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DESCRIPTION:	SOT-953 1.00x0.80x0.37, 0.35P		PAGE 1 OF 1

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MILLIMETERS						
DIM	MIN	NDM	MAX			
A	0,34	0.37	0,40			
b	0.10	0.15	0.20			
С	0.07	0.12	0.17			
D	0,95	1,00	1.05			
E	0,75	0,80	0.85			
e	0.35 BSC					
Н	0,95	1.00	1.05			
Ĺ	0.125	0.175	0.225			
L2	0.05	0.10	0.15			
L3	0.075 (REF)					



RECOMMENDED MOUNTING FOOTPRINT

*For additional information on our Pb-Free strategy and soldering details, please download the DN Semiconductor Soldering and Mounting Techniques Reference Manual, SDLDERRM/D.

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